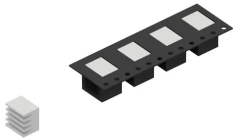


Data sheet Product ICK SMD F 8 MI TR



Heatsinks and active heatsinks for processors>Heatsinks for DIL-IC, PLCC and SMD

10 x 6 mm, for SMD components and others

Features

case type:	SMD
thermal resistance:	74 K/W
surface:	solderable surface
diameter of tape:	330 mm
width of belt:	16 mm
quantity per reel:	700

Technical Drawing

